



SCD Series

Features

- u Approximately zero leaking current before clamping voltage
- u Less decay at on/off state.
- u High capability to withstand repeated lightning strikes.
- Low electrode capacitance (≤1.0pF) and high isolation (≥100MΩ).
- u RoHS compliant.
- u Bilateral symmetrical.
- u Temperature, humidity and lightness insensitive.
- u Operating temperature: -40 °C ~ +85 °C
- u Storage temperature: -40°C ~ +125°C
- u Meets MSL level 1, per J-STD-020



- u Power Supplies
- u Motor sparks eliminating
- u Relay switching spark absorbing
- u Data line pulse guarding
- u Electronic devices requiring UL497A and UL497B compliant
- u Telephone/Fax/Modem
- u High frequency signal transmitters/receivers
- u Satellite antenna
- u Radio amplifiers
- u Alarm systems
- u Cathode ray tubes in Monitors/TVs

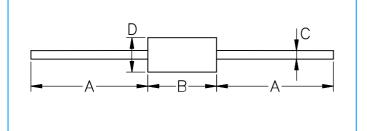
Part Numbering

<u>SCD</u> - <u>201</u> <u>M</u>

(1) (2) (3)

- (1) Series
- (2) V_S Voltage, e.g. 201=20X10¹=200V
- (3) V_S Voltage tolerance: L $\pm 15\%$, M $\pm 20\%$, N $\pm 30\%$

Dimensions



Dimensions	Inches	Millimeters
Α	1.102±0.079	28.0±2.0
В	0.169±0.039	4.3±0.05
С	0.020±0.002	0.5±0.05
D	0.122±0.020	3.1±0.5





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Electrical Characteristics

Part Number	DC Spark-over Voltage Vs(V)	Minimum Insulation Resistance IR(OHM)/DC	Maximum Capacitance 1KHZ-6Vmax C (pF)	Surge Current Capacity 8/20 μS	Surge Life Test
SCD-181N	180(126~234)	100M / 50V	1.0	3000A	10KV / 150A , >300T
SCD-201M	200(160~240)	100M /100V	1.0	3000A	10KV / 150A , >300T
SCD-301M	300(240~360)	100M /100V	1.0	3000A	10KV / 150A , >300T
SCD-401M	400(320~480)	100M / 250V	1.0	3000A	10KV / 150A , >300T
SCD-501M	500(400~600)	100M / 250V	1.0	3000A	10KV / 150A , >300T

Color Code

Part Number	Color Code1	Color Code2	Color Code3
SCD-181N	Gray	-	-
SCD-201M	Red	-	-
SCD-301M	Orange	-	-
SCD-401M	Yellow	-	-
SCD-501M	Green	-	-





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Test Methods and Results

Items	Test Method		Test Method	Standard
DC Spark-over Voltage	Measure starting discharge voltage (Vs) by gradually increasing applied DC voltage. Test current is 0.5mA max. And the DC voltage ascends up within 100V/s(Vs≤1000V) or 500V/s(Vs≥1000V).			Rate-of-change, within±30%
Insulation Resistance	a		tion resistance across the terminal But the test voltage doesn't over voltage.	insulation resistance & capacitance, conformed to rated spec.
Capacitance			ostatic capacitance by applying a 6V (at 1KHz) between terminals.	
Static Life	10KV with 1500pf condenser is discharged through 2KΩ resistor. 200 times at an interval of 10sec.			△Vs/Vs ≤30% Characteristics of other items must meet the specified value
	The following impulse current for specified current applied ±5 times, each time interval 60 seconds. Thereafter, outer appearance shall be visually examined.			
Surge Current Capacity		Туре	Impulse current	No crack and no failures
Сараску		Vs < 400V	1.2/50µs & 8/20µs, 500A	
		Vs ≥ 400V	1.2/50μs & 8/20μs, 500A, electrically connected with a resistor (1~2 Ω).	
Cold Resistance		leasurement afte emperature/2 HRS	r -40 ℃ /1000 HRS & normal	
Heat Resistance		leasurement after emperature/2 HRS	r 125 $^{\circ}$ /1000 HRS & normal .	
Humidity Resistance		leasurement after RS & normal temp	humidity $90{\sim}95^{\circ}\mathrm{C}(45^{\circ}\mathrm{C}$) /1000 perature/2 HRS.	Features are conformed to rated spec
Temperature Cycle	10 times repetition of cycle -40°C /30min →normal, temp/2 min →125°C/30min, measurement after normal temp/2 HRS.			
Solder Ability	Apply flux and immerse in molten solder 230±5°C for 3sec up to the point of 1.5mm from body. Check for solder adhesion.			Lead wire is evenly covered by solder
Solder Heat	Measurement after lead wire is dipped up to the point of 1.5mm from body into 260±5°C solder for 10sec			Conformed to rated spec
Pull Strength	Apply 0.5kg load for 10sec			
Flexural Strength	Bend lead wire at the point of 2mm from body under 0.25 load and back to its original point. Repeat 1 time.			Lead shall not pull out to snap

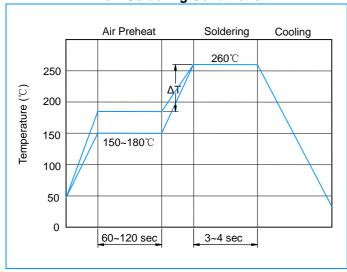




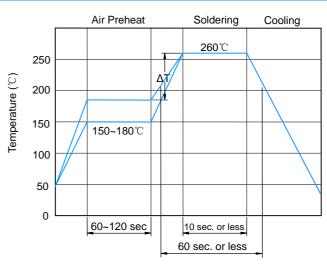
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Recommended Soldering Conditions

Flow Soldering Conditions



Reflow Soldering Conditions



- 1) Time shown in the above figures is measured from the point when chip surface reaches temperature.
- 3) After soldering, do not force cool, allow the parts to cool gradually.

Hand Soldering

Solder iron temperature: $350\pm5\,^{\circ}$ C Heating time: 3 seconds max.

General attention to soldering

- **u** High soldering temperatures and long soldering times can cause leaching of the termination, decrease in adherence strength, and the change of characteristic may occur.
- u For soldering, please refer to the soldering curves above. However, please keep exposures to temperatures exceeding 200 ℃ to fewer than 50 seconds.
- u Please use a mild flux (containing less than 0.2wt% CI). Also, if the flux is water soluble, be sure to wash thoroughly to remove any residue from the underside of components that could affect resistance.

Cleaning

When using ultrasonic cleaning, the board may resonate if the output power is too high. Since this vibration can cause cracking or a decrease in the adherence of the termination, we recommend that you use the conditions below:

4/5

Frequency: 40kHz max.

Output power: 20W/liter

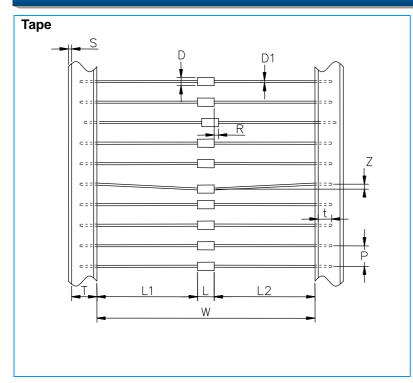
Cleaning time: 5 minutes max.



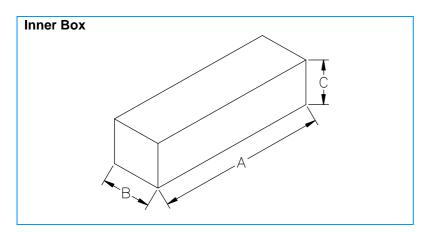


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Packaging



Symbol	Dimension (mm)	
w	52+2.0/-1.0	
Р	5.0±0.5	
Т	6.0±1.0	
Z	1.2 Max	
L1-L2	1.0 Max	
S	0.8 Max	
t	3.2 Max	
L	4.3±0.5	
D1	Ф0.5±0.05	
D	D Φ3.1±0.5	
R	R 1.0 Max	



Item	Description	
Length	A=255 mm	
Width	B=75 mm	
Height	C=68 mm	
Quantity	2000 PCS	
Package There are upper and bottom board to protect the part from damage.		